

Q28-100GP4-BXU2931-20-I-OPC

MSA and TAA 100GBase-BX LR1 PAM4 QSFP28 Transceiver Single Lambda (SMF, 1291nmTx/1311nmRx, 20km, LC, DOM, -40 to 85C)

Features

- Compliant with Industry Standards 100G-LR1-20 Lambda MSA
 - Compliant with SFF-8661, SFF-8636, and SFF-8679 MSA
- Hardware Specifications
- PIN Receiver
 - EML Laser
 - Up to 20km on 9/125μm SMF
 - Operating Temperature: -40 to 85 Celsius
 - RoHS Compliant and Lead-Free
 - Industrial Temperature -40 to 85 Celsius
 - RoHS Compliant and Lead Free



Applications:

- 100GBase Ethernet
- Datacenter

Product Description

This MSA compliant QSFP28 transceiver provides 100GBase-BX LR1 throughput up to 20km over single-mode fiber (SMF) PAM4 using a wavelength of 1291nmTx/1311nmRx via an LC connector. This bidirectional unit must be used with another transceiver or network appliance of complementing wavelengths. It can operate at temperatures between -40 and 85C. All of our transceivers are built to comply with Multi-Source Agreement (MSA) standards and are uniquely serialized and tested for data-traffic and application to ensure seamless network integration. Additional product features include Digital Optical Monitoring (DOM) support which allows access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Operating Temperature	Tc	-40		85	°C	
Storage Temperature	Tstg	-40		85	°C	
Relative Humidity	RH	15		85	%	
Supply Voltage	Vcc	0		3.6	V	
Data Input Voltage		-0.3		3.6	V	
Control Input Voltage		-0.3		4	V	
Data Rate	DR		53.125 ± 100ppm		GBd	
Bit Error Rate	BER			2.4E ⁻⁴		1
Supported Link Length on 9/125µm SMF @53.125GBd	L		20		km	2

Notes:

1. Tested with a PRBS31Q test pattern for 53.125GBd operation.
2. Distances are based on FC-PI-6 Rev. 3.1 and IEEE 802.3 standards with FEC.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Power Supply Voltage	Vcc	3.13	3.3	3.47	V	
Module Supply Current	Icc			1437	mA	1
Power Dissipation	PD			4500	mW	
Transmitter						
Differential Input Impedance	ZIN	90	100	110	Ω	
Differential Data Input Swing	VIN,pp	180		900	mVp-p	
Receiver						
Differential Output Impedance	ZOUT	90	100	110	Ω	
Differential Data Output Swing	VOOUT,pp	300		900	mVp-p	

Notes:

1. The maximum current is calculated at the minimum supply voltage.

Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Average Launch Optical Power	Po	-0.2		6.6	dBm	1
Launch Optical Power (OMA)	Poma	2.8		6.8	dBm	2
		1.4+TDECQ				3
Extinction Ratio	ER	3.5			dB	
Center Wavelength	λ_C	1284.5	1291	1297.5	nm	
Transmitter and Dispersion Penalty Eye Closure for PAM4	TDECQ			3.6	dB	
Transmitter Eye Closure for PAM4	TECQ			3.4	dB	
RIN _{17.1} OMA (Maximum)	RIN			-136	dB/Hz	
Optical Return Loss Tolerance	ORLT			15.6	dB	
POUT @Tx_Disable Asserted	Poff			-15	dBm	
Receiver						
Center Wavelength	λ_C	1304.5	1311	1317.5	nm	
Receiver Sensitivity (OMA)	RxSENS			-7.6	dBm	1, 4
				-9+TECQ		5
Receiver Reflectance				-26	dB	
LOS De-Assert	LOSD			-12	dBm	
LOS Assert	LOSA	-18			dBm	
LOS Hysteresis		0.5			dB	

Notes:

1. Measured with PRBS31Q test pattern, @53.125GBd, and BER<2.4E⁻⁴.
2. TDECQ < 1.4dB.
3. 1.4dB ≤ TDECQ ≤ TDECQ, maximum.
4. TECQ < 1.4dB.
5. 1.4dB < TECQ ≤ 3.6dB.

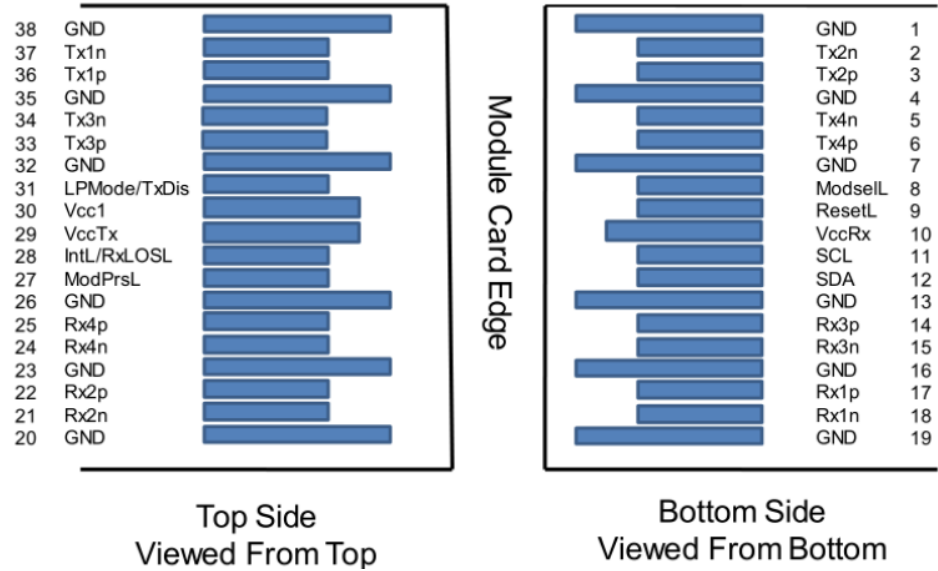
Pin Descriptions

Pin	Logic	Symbol	Name/Description	Notes
1		GND	Module Ground.	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Output.	
4		GND	Module Ground.	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	
7		GND	Module Ground.	1
8	LVTTTL-I	ModSelL	Module Select.	2
9	LVTTTL-I	ResetL	Module Reset.	2
10		VccRx	+3.3V Receiver Power Supply.	
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock.	2
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	2
13		GND	Module Ground.	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	
15	CML-O	Rx3-	Receiver Inverted Data Output.	
16		GND	Module Ground.	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	
18	CML-O	Rx1-	Receiver Inverted Data Output.	
19		GND	Module Ground.	1
20		GND	Module Ground.	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	
23		GND	Module Ground.	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	
26		GND	Module Ground.	1
27	LVTTTL-O	ModPrsL	Module Present.	
28	LVTTTL-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636).	2
29		VccTx	+3.3V Transmitter Power Supply.	
30		Vcc1	+3.3V Power Supply.	
31	LVTTTL-I	LPMode/TxDis	Low-Power Mode. Optionally configurable as TxDis via the management interface (SFF-8636).	2
32		GND	Module Ground.	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	
35		GND	Module Ground.	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	
38		GND	Module Ground.	1

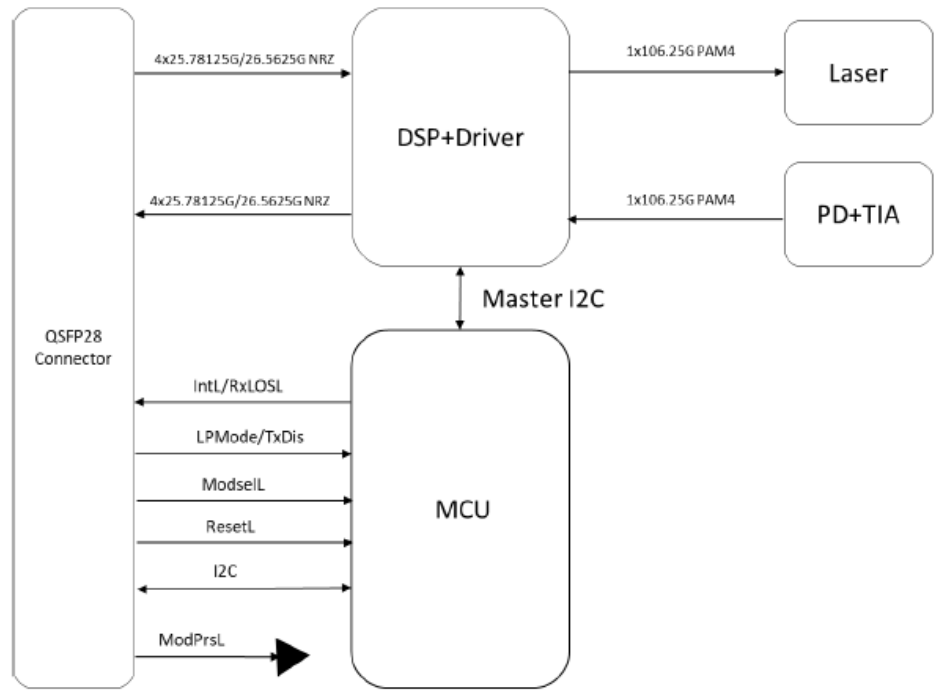
Notes:

- 1. GND is the symbol for signal and supply (power) common for the module. All are common within the module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2. VccRx, Vcc1, and VccTx are applied concurrently and may be internally connected within the module in any combination. Vcc contacts in SFF-8662 and SFF-8672 each have a steady state current rating of 1A.

Electrical Pin-Out Details



Block Diagram



Mechanical Specifications

